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STG3P2M10N60B

1 phase bridge rectifier + 3 phase inverter IGBT - SEMITOP[®]2 module

Features

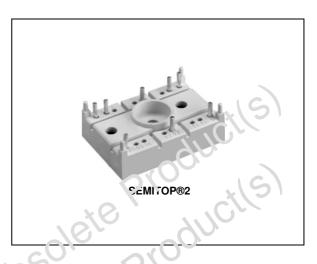
- Low on-voltage drop (V_{CE(sat)})
- Low C_{RES} / C_{IES} ratio (no cross-conduction susceptibility)
- Very soft ultra fast recovery antiparallel diode
- High frequency operation up to 70 kHz
- One screw mounting
- Compact design
- Semitop[®]2 is a trademark of Semikron

Applications

- High frequency motor controls
- Motor drivers

Description

Using the latest high voltage technology based on a patented strip layout, STMicroelectionics has designed an advanced famil / of GBTs, the PowerMESH™ IGBT, with cutstanding JOSOlete Produl Tet alete



listernal schematic diagram Figure 1.

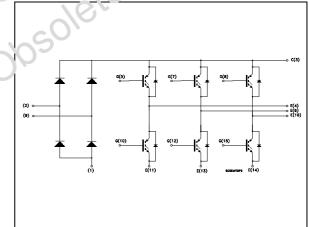


Table 💭 Device summary	Table		Device	summary
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Order code	Marking	Package	Packaging
STG3P2M10N60B	G3P2M10N60B	SEMITOP®2	Semibox

Contents

1	Electrical ratings
2	Electrical characteristics
	2.1 Typical characteristics (curves)
3	Test circuit
4	Package mechanical data
5 0050 0050	Electrical ratings



Electrical ratings 1

Table 2. Absolute maximum ratings	olute maximum ratings	Absolute	Table 2.
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Symbol	Parameter	Value	Unit
V_{CES}	Collector-emitter voltage ($V_{GE} = 0$)	600	V
$I_{C}^{(1)}$	Collector current (continuous) at T_s = 25 °C	19	А
$I_{C}^{(1)}$	Collector current (continuous) at T _s = 80 °C	10	А
V_{GE}	Gate-emitter voltage	±20	V
$I_{CM}^{(2)}$	Collector current (pulsed, $t_p < 1$ ms) T _s =25 °C	38	A
I _{CM} ⁽²⁾	Collector current (pulsed, $t_p < 1 \text{ ms}$) T _s =80 °C	20	A
۱ _F	Diode RMS forward current at T_s = 25 °C		А
P _{TOT}	Total dissipation at T_s = 25 °C	56	W
V _{ISO}	Insulation withstand voltage A.C. (t=1 min/sec; T _s = 25 °C)	2500/3000	V
T _{stg}	Storage temperature	- 40 to 125	°C
Тj	Operating junction temperat ire	- 40 to 150	°C
. Calculate . Pulse wic	th limited by max. Jurction emperature		

(1)	
tance junction-sink ^{(1)} max.	2.2
1	uctive grease applied and maximum r



2 **Electrical characteristics**

(T_s = 25 °C unless otherwise specified)

able 4.	Static					
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)CES}	Collector-emitter breakdown voltage (V _{GE} = 0)	I _C = 1 mA	600			v
I _{CES}	Collector cut-off current (V _{GE} = 0)	V _{CE} = 600 V V _{CE} = 600 V, T _S = 125 °C			10 19	µA .nA
I _{GES}	Gate-Emitter Leakage Current (V _{CE} = 0)	V _{GE} = ±20 V	2	JC	±100	nA
$V_{GE(th)}$	Gate Threshold Voltage	$V_{CE} = V_{GE}$, $I_C = 250 \ \mu A$	3.75	ĺ	5.75	v
V _{CE(sat)}	Collector-emitter saturation voltage	V _{GE} = 15 V, I _C = 7 A V _{GE} = 15 V, I _C = 7 A, = 125 °C		1.85 1.7	2.5	v v

Table / Statio

Table 5. Dynamic

				_			
	ole 5. /mbol	Dynamic Parameter	Test conditions	Kin.	Тур.	Max.	Unit
		rarameter			Typ.	max.	
g) _{fs} ⁽¹⁾	Forward transconductance	$V_{CE} = 15 V_{,} I_{C} = 7 A$		4.30		S
C	C _{ies} C _{oes} C _{res}	Input capacitation Output capacitation Revellse transfer capacitance	V _{CE} = 25 V, f = 1 MHz, V _{GE} = 0		720 81 17		pF pF pF
×9	Q _g C _{Je} Q _{gc}	Total gate charge Gate-emitter charge Gate-collector charge	$V_{CE} = 390 \text{ V}, I_{C} = 5 \text{ A},$ $V_{GE} = 15 \text{ V}, \text{ (see Figure 9)}$		35 7 16	48	nC nC nC
Obsolete Obsolete	Q.	bulse duration=300µs, duty cycle	1.5%				



Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	$V_{CC} = 300 \text{ V}, I_C = 7 \text{ A}$ $R_G = 22 \Omega, V_{GE} = \pm 15 \text{ V}$ (see Figure 10)		18.5 8.5 1060		ns ns A/µs
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	$V_{CC} = 300 \text{ V}, I_C = 7 \text{ A}$ $R_G = 22 \Omega, V_{GE} = \pm 15 \text{ V}$ $T_s = 125^{\circ}\text{C} \text{ (see Figure 10)}$		18.5 7 1000		ns ns A/µs
t _r (V _{off}) t _{d(off}) t _f	Off voltage rise time Turn-off delay time Current fall time	$V_{CC} = 300 \text{ V}, I_C = 7 \text{ A}$ $R_G = 22 \Omega, V_{GE} = \pm 15 \text{ V}$ (see Figure 10)		27 72 60	6	ns ns ns
t _r (V _{off}) t _d (_{off}) t _f	Off voltage rise time Turn-off delay time Current fall time	$V_{CC} = 300 \text{ V}, I_C = 7 \text{ A}$ $R_G = 22 \Omega, V_{GE} = \pm 15 \text{ V}$ $T_s = 125 \text{ °C}$ (see Figure 1%)	0	56 116 105	lè	ns ns ns
Table 7.	Switching energy (indu	ctive load)		40		

Table 6. Switching on/off

Switching energy (inductive load) Table 7.

S	Symbol	Parameter	Tratconditions	Min.	Тур.	Max.	Unit
	E _{on} ⁽¹⁾ E _{off} ⁽²⁾ E _{ts}	Turn-on switching losses Turn-off switching losses Total switching losses	$V_{CC} = 300 \text{ V}, I_C = 7 \text{ A}$ $R_G = 22 \Omega, V_{GE} = \pm 15 \text{ V}$ (see Figure 10)		95 115 210		μJ μJ μJ
	E _{on} ⁽¹⁾ E _{off} ⁽²⁾ E _t	Turn-on switching losses Turn of switching losses Tota switching losses	$V_{CC} = 300 \text{ V}, I_C = 7 \text{ A}$ $R_G = 22 \Omega, V_{GE} = \pm 15 \text{ V}$ $T_s = 125 \text{ °C}$ (see Figure 10)		140 215 355		μJ μJ
Obsole ¹	a پackage same terr Turn-off le		ode is used in the test circuit in figu k diode is used as external diode. collector current				in
0105010							

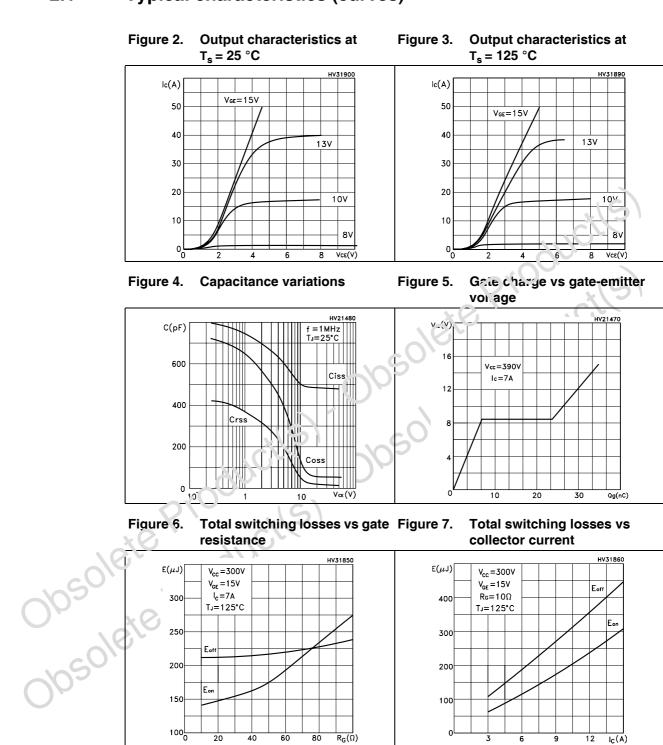


Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _F	Forward on-voltage	I _F = 3.5 A		1.3	1.9	V
1		I _F = 3.5 A, T _s = 125 °C		1.1		V
t _{rr}	Reverse recovery time			37		ns
t _a		I _F = 7 A,V _B = 40 V,		22		ns
Q _{rr}	Reverse recovery charge	di/dt = 100 A/µs		40		nC
l _{rrm}	Reverse recovery current	(see Figure 7)		2.1		А
S	Softness factor of the diode			0.68		
t _{rr}	Reverse recovery time			6		ns
t _a		I _F = 7 A,V _B = 40 V,		34		ns
Q _{rr}	Reverse recovery charge	di/dt = 100 A/µs	0	98		nC
I _{rrm}	Reverse recovery current	(see Figure 7)		3.2	XC	A
S	Softness factor of the diode	<u>×0</u>		0.79		
		der	. ~	30.		
Table 9.	Bridge rectifier diode	S O	5			

Table 8. **Collector-emitter diode**

Table 9.	Bridge rectifier diode Parameter	rest conditions	Min.	Тур.	Max.	Unit
_	Forward on-voltage	$I_{\rm F} = 20$ A, $T_{\rm s} = 125$ °C		1.1		V
	Thermal resistance	-105 ⁰¹⁰			2.15	K/W
	Operating junction temperature	07	-40		150	°C
oletePr	00.0					
. O. Y	*					

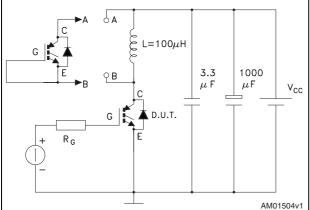


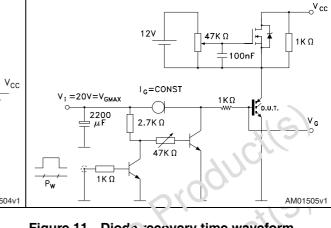


2.1 Typical characteristics (curves)

3 **Test circuits**

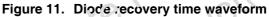






Gate charge test circuit





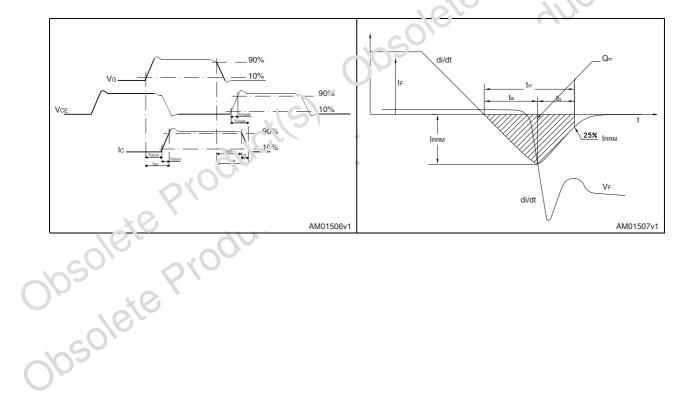


Figure 9.



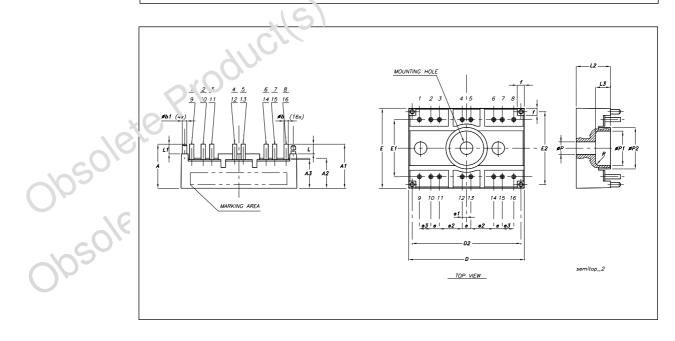
4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

Obsolete Product(s) - Obsolete Product(s) Obsolete Product(s) - Obsolete Product(s) Obsolete Product(s) - Obsolete Product(s)

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Dim	mm		
	Min	Тур	Мах
A	15.30	15.50	15.70
A1	15.23	15.43	15.63
A2		10.50	
A3		10	
øb		1.50	
øb1		1.60	
D	40.20	40.50	40.80
D2		38	5
E	27.80	28	28 70
E1	19.80	20	20.?
E2		25.50	710
е	2.90	3	3.10
e1		1.50	<u> </u>
e2	7.80	8	8.20
e3	3.90	4	4.10
f		2.50	
L		3.4 5	
L1		3.50	
L2	11.80	12	12.20
L3		5.20	
øP	4.30	4.40	4.50
øP1		12	
øp2		14.50	
R		1	



5 Revision history

Table 10. Document revision history

Date	Revision	Changes
15-May-2005	1	Initial release.
15-Oct-2008	2	Document status promoted from preliminary data to datasheet.

Obsolete Product(s) - Obsolete Product(s) Obsolete Product(s) - Obsolete Product(s)



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